

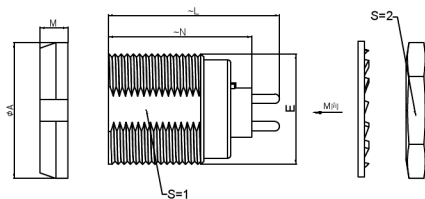
1.View and size(视图及尺寸)

Main technical indicators(主要技术指标)	
1.Mating (插拔次数)	5000
2.Working Temperature (温度)	-55~+150 ℃
3.IP Rating (防护级别)	IP 50
4.Diameter of socket end(插合端直径)	φ0.5
5.Testing Voltage (测试电压)	600V
6.Working Voltage (工作电压)	500V
7.Rated Current (额定电流)	2.0A
8.Shell material(壳体材质)	Brass (chromium plating)/(nickel plating) fixation ring/ 黄铜(镀铬)/镍(镀镍) 固定圈
9.Pin Material(插针材料)	Copper alloy gold plating(铜合金镀金)
10.Insulator material(绝缘体材质)	PPS

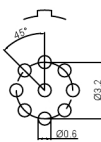
Sum up(总结)	
Series(系列)	B
Shell style/model (外壳样式/型号)	ZCG-VWith two nuts (fix back and forth)带有两个螺母(前后固定)
Button (按键)	A button(一个按键)
Termination type (终止类型)	Female print PCB(印刷PCB)
Line diameter awg(线材直径)	34AWG-28AWG
Cable diameterφ (电缆直径)	0-0
Match plug(匹配插头)	TGG.0B.P09.CLAD52H

Location pin combination (定位销组合)			
(编号) Numder	Number of positioning pins(定位销数量)	Angle(角度)	Series(系列)-0B
G	One(1)	A	(Zero degrees)0°
A	Two(2)		Thirty degrees(30°)
B	Two(2)		Sixty degrees(60°)
C	Two(2)		Ninety degrees(90°)
D	Two(2)	β	135 degrees(135°)
E	Two(2)		145 degrees(145°)
F	Two(2)		155 degrees(155°)
J	Two(2)	Y	Forty-five degrees(45°)
K	Two(2)		Seventy degrees(70°)
L	Two(2)		80 degrees(80°)

	A	B	C√	ANGLE	
5-10	±0.02	±0.05	±0.1	0°-30°	±0.1°
50-100	±0.1	±0.15	±0.2	61°-90°	±0.5°
50-100	±0.15	±0.2	±0.25		
100-	±0.15%	±0.20%	±0.25%		



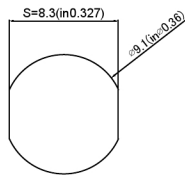
	A	N	L	E	M	S1	S2
MM	φ12	16.3	19.6	M9*0.6	2.5	8.2	11
in	0.4725	0.64	0.77		0.0984	0.323	0.433



Pcb plate opening size
(PCB板开孔尺寸)



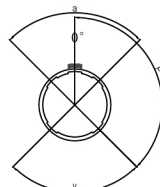
M向



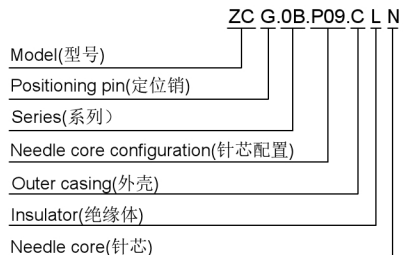
Pane hole size
(面板开孔尺寸)



Boarded mother adhesive core
(板接型母胶芯)



Positive view of the socket
(插座正视图)



DESIGNED (设计)		DATE(日期)		SCALE(比例)	N/A(不适用)	MODEL TYPE 型号类型: ZCG.0B.P09.CLN
CHECKED (校对)		DATE(日期)		VIEW(视图)		PART NO. 0B9-core socket
APPROVED (审核)		DATE(日期)		UNIT(单位)	MM	名称: 0B9芯插座
REVISIONS				MATERIAL (材料)		DWG NO.:
www.helloxb.com www.helloxb.cn				XKB INDUSTRIAL PRECISION CO.,LIMITED		WEIGHT(重量) SHEET(张) REVISION(修订)
						1/1 A0